

# **Film Capacitors**

Metallized Polypropylene Film Capacitors (MKP)

Series/Type: B32754 ... B32758

Date: October 2018

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#### **MKP AC filtering**

#### **Typical applications**

Output AC filtering for power converters, UPS, motor drives

#### Climatic

- Max. operating temperature: 105 °C
- Climatic category (IEC 60068-1:2013): 40/85/56

#### Construction

- Dielectric: Polypropylene (PP)
- Plastic case (UL 94 V-0)
- Epoxy resin sealing (UL 94 V-0)

#### **Features**

- THB Grade III Test A (refer to IEC60384-14:2013/AMD1:2016)
- Optimized AC voltage performance
- High ripple current/frequency handling capability
- For PCB mounting

#### **Terminals**

- Parallel wire leads, lead-free tinned
- 2-pin and 4-pin versions
- Standard lead lengths: 6 –1 mm
- Special lead lengths available on request

#### Marking

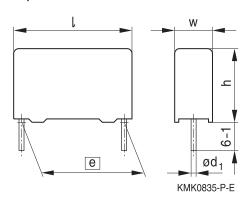
Manufacturer's logo, lot number, series number, rated capacitance (code), capacitance tolerance (code with letter), rated AC voltage, date of manufacture (code)

### **Delivery mode**

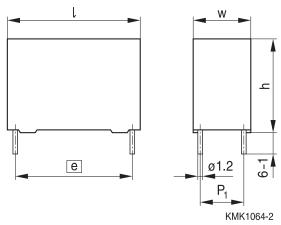
Bulk (untaped, lead length 6-1 mm)

#### **Dimensional drawings**

#### 2-pin version



#### 4-pin version



#### Dimensions in mm

Version	Lead spacing e ±0.4	Lead diameter d <sub>1</sub> ±0.05	Туре
2-pin	27.5	0.8	B32754C
2-pin	37.5	1.0	B32756C
4-pin	37.5	1.01)/1.2	B32756G
4-pin	52.5	1.2	B32758G

<sup>1)</sup> For box dimensions  $22.0 \times 45.0 \times 42.0$  mm







## Ordering code examples

В	3275	4	С	3	105	K
Components	Series	Lead space	Pin	Rated voltage	Rated	Capacitance
class		(mm)	number		capacitance	tolerance
Passive	MKP	4 = 27.5	C = 2 pins	2 = 250 V AC	105 = 1000 nF	J = ±5%
components		6 = 37.5	G = 4 pins	3 = 310 V AC	= 1.0 ηF	$K = \pm 10\%$
		8 = 52.5		4 = 400 V AC		+ = K or J
				7 = 275 V AC		
				8 = 350 V AC		

## Voltage ratings

$\overline{V_{NDC}}$	500 V DC	550 V DC	580 V DC	600 V DC	800 V DC
$\overline{V}_{NAC}$	350 V AC	380 V AC	430 V AC	480 V AC	560 V AC
$V_{RMS}$	250 V AC	275 V AC	310 V AC	350 V AC	400 V AC

#### Note:

 $V_{\text{NAC}}$  is maximum operating peak recurrent voltage of either polarity of a reversing type waveform, not an RMS value.





## **MKP AC filtering**

## Overview of available types

Lead spacing	Lead spacing 27.5 mm				37.5 mm			52.5 mm							
Туре	B327	754				B32756			B32758						
Page	5					7					9				
V <sub>RMS</sub> (V AC)	250	275	310	350	400	250	275	310	350	400	250	275	310	350	400
$C_R (\mu F)$															
1.0															
1.5															
2.0															
2.5															
3.0															
3.5															
4.0															
4.5															
5.0															
6.0															
7.0															
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35															
40															
45															
50															
55															
60															
65															
70															







## Ordering codes and packing units (lead spacing 27.5 mm)

$V_{RMS}$	$V_R$	$C_R$	Max. dimensions	P <sub>1</sub>	Ordering code	I <sub>RMS</sub>	ESR <sub>typ</sub>	Untaped
			$w \times h \times l$		(composition see	70 °C	10 kHz	
					below)	10 kHz		
V AC	V DC	μF	mm	mm		Α	mΩ	pcs./MOQ
250	500	1.0	$11.0 \times 19.0 \times 31.5$	_	B32754C2105+000	2.5	30.2	2352
		2.0	$12.5 \times 21.5 \times 31.5$	_	B32754C2205+000	4.0	16.9	2100
		3.0	$14.0 \times 24.5 \times 31.5$	_	B32754C2305K000	5.0	12.1	1848
		4.0	$16.0 \times 32.0 \times 31.5$	_	B32754C2405+000	6.0	9.0	1064
		5.0	$16.0 \times 32.0 \times 31.5$	_	B32754C2505+000	7.0	7.6	1064
		6.0	$18.0 \times 33.0 \times 31.5$	_	B32754C2605+000	8.0	6.6	952
		7.0	$22.0 \times 36.5 \times 31.5$	_	B32754C2705+000	9.0	5.5	784
		8.0	$22.0 \times 36.5 \times 31.5$	_	B32754C2805+000	9.5	5.3	784
		9.0	$22.0 \times 36.5 \times 31.5$	_	B32754C2905+000	10.0	4.9	784
		10	$22.0 \times 36.5 \times 31.5$	_	B32754C2106K000	11.0	4.7	784
		12	$22.0 \times 48.0 \times 31.5$	_	B32754C2126+000	12.0	4.4	320
		14	$22.0 \times 48.0 \times 31.5$	_	B32754C2146K000	12.0	4.2	320
275	550	1.0	$11.0 \times 19.0 \times 31.5$	_	B32754C7105+000	2.5	30.2	2352
		1.5	$12.5 \times 21.5 \times 31.5$	_	B32754C7155+000	3.5	20.5	2100
		2.0	$13.5 \times 23.0 \times 31.5$	_	B32754C7205+000	4.3	15.5	1932
		2.5	$15.0 \times 24.5 \times 31.5$	_	B32754C7255+000	5.0	12.7	1680
		3.0	$16.0 \times 32.0 \times 31.5$	_	B32754C7305+000	6.0	10.0	1064
		4.0	$18.0 \times 33.0 \times 31.5$	_	B32754C7405+000	7.0	8.0	952
		5.0	$18.0 \times 33.0 \times 31.5$	_	B32754C7505K000	8.0	7.4	952
		6.0	$22.0 \times 36.5 \times 31.5$	_	B32754C7605+000	9.0	6.1	784
		7.0	$22.0 \times 36.5 \times 31.5$	_	B32754C7705+000	10.0	5.5	784
		8.0	$22.0 \times 48.0 \times 31.5$	_	B32754C7805+000	11.0	5.1	320
		9.0	$22.0 \times 48.0 \times 31.5$	_	B32754C7905+000	11.0	4.9	320
		10	$22.0 \times 48.0 \times 31.5$	_	B32754C7106+000	12.0	4.6	320

MOQ = Minimum Order Quantity, consisting of 4 packing units. Further E series and intermediate capacitance values on request.

### Composition of ordering code

+ = Capacitance tolerance code:

 $K = \pm 10\%$ 





## **MKP AC filtering**

## Ordering codes and packing units (lead spacing 27.5 mm)

$V_{RMS}$	$V_R$	C <sub>R</sub>	Max. dimensions	P <sub>1</sub>	Ordering code	I <sub>RMS</sub>	ESR <sub>typ</sub>	Untaped
			$w \times h \times l$		(composition see	70 °C	10 kHz	
					below)	10 kHz		
V AC	V DC	μF	mm	mm		Α	mΩ	pcs./MOQ
310	580	1.0	$11.0 \times 21.0 \times 31.5$	_	B32754C3105+000	3.0	28.1	2352
		1.5	$13.5 \times 23.0 \times 31.5$	_	B32754C3155+000	3.8	18.5	1932
		2.0	$14.0 \times 24.5 \times 31.5$	_	B32754C3205K000	4.6	15.1	1848
		2.5	$16.0 \times 32.0 \times 31.5$	_	B32754C3255K000	5.5	11.7	1064
		3.0	$18.0 \times 27.5 \times 31.5$	_	B32754C3305+000	6.5	10.0	1428
		3.5	$18.0 \times 33.0 \times 31.5$	_	B32754C3355+000	7.0	8.7	952
		4.0	$19.0 \times 30.0 \times 31.5$	_	B32754C3405K000	7.5	8.2	896
		4.5	$21.0 \times 31.0 \times 31.5$	_	B32754C3455+000	8.2	7.2	784
		5.0	$22.0 \times 36.5 \times 31.5$	_	B32754C3505+000	9.0	6.7	784
		6.0	$22.0 \times 36.5 \times 31.5$	_	B32754C3605K000	9.6	6.0	784
		7.0	$22.0 \times 48.0 \times 31.5$	_	B32754C3705+000	10.0	5.5	320
		8.0	$22.0 \times 48.0 \times 31.5$	_	B32754C3805+000	11.0	5.1	320
		9.0	$22.0 \times 48.0 \times 31.5$	_	B32754C3905K000	12.0	4.7	320
350	600	1.0	$11.0 \times 21.0 \times 31.5$	_	B32754C8105+000	3.5	18.9	2352
		1.5	$13.5 \times 23.0 \times 31.5$	_	B32754C8155+000	4.5	12.9	1932
		2.0	$15.0 \times 24.5 \times 31.5$	_	B32754C8205K000	5.5	10.4	1680
		2.5	$16.0 \times 32.0 \times 31.5$	_	B32754C8255+000	6.5	8.2	1064
		3.0	$18.0 \times 33.0 \times 31.5$	_	B32754C8305+000	7.5	7.1	952
		3.5	$18.0 \times 33.0 \times 31.5$	_	B32754C8355+000	8.0	6.4	952
		4.0	$21.0 \times 31.0 \times 31.5$	_	B32754C8405K000	9.0	5.8	784
		4.5	$22.0 \times 36.5 \times 31.5$	_	B32754C8455+000	9.5	5.2	784
		5.0	$22.0 \times 36.5 \times 31.5$	_	B32754C8505+000	10.0	4.9	784
		6.0	$22.0 \times 48.0 \times 31.5$	_	B32754C8605+000	11.0	4.7	320
		7.0	$22.0 \times 48.0 \times 31.5$	_	B32754C8705+000	11.0	4.3	320
400	800	1.0	$14.0 \times 24.5 \times 31.5$	_	B32754C4105K000	4.5	16.2	1848
		1.5	$18.0 \times 27.5 \times 31.5$	_	B32754C4155+000	6.0	11.0	1428
		2.0	$21.0 \times 31.0 \times 31.5$	_	B32754C4205+000	7.0	8.4	784
		2.5	$22.0 \times 36.5 \times 31.5$	_	B32754C4255+000	8.0	7.1	784
		3.0	$22.0 \times 36.5 \times 31.5$	_	B32754C4305K000	8.5	6.5	784
		4.0	$22.0 \times 48.0 \times 31.5$	_	B32754C4405+000	10.0	5.4	320

MOQ = Minimum Order Quantity, consisting of 4 packing units. Further E series and intermediate capacitance values on request.

### Composition of ordering code

+ = Capacitance tolerance code:

 $K = \pm 10\%$ 







## Ordering codes and packing units (lead spacing 37.5 mm)

$V_{RMS}$	$V_R$	$C_R$	Max. dimensions	P <sub>1</sub>	Ordering code	I <sub>RMS</sub>	ESR <sub>typ</sub>	Untaped
			$w \times h \times l$		(composition see	70 °C	10 kHz	
					below)	10 kHz		
V AC	V DC	μF	mm	mm		Α	mΩ	pcs./MOQ
250	500	5.0	$18.0 \times 32.5 \times 42.0$	_	B32756C2505+000	7.0	12.2	720
		6.0	$18.0 \times 32.5 \times 42.0$	_	B32756C2605+000	7.0	10.3	720
		7.0	$18.0 \times 32.5 \times 42.0$	_	B32756C2705+000	7.0	9.7	720
		8.0	$18.0 \times 32.5 \times 42.0$	_	B32756C2805+000	8.0	9.4	720
		9.0	$18.0 \times 32.5 \times 42.0$	_	B32756C2905+000	8.5	8.5	720
		10	$20.0 \times 39.5 \times 42.0$	10.2	B32756G2106+000	10.0	6.6	640
		12	$20.0 \times 39.5 \times 42.0$	10.2	B32756G2126+000	11.0	6.1	640
		15	$22.0 \times 45.0 \times 42.0$	10.2	B32756G2156+000	12.0	5.0	560
		20	$28.0 \times 42.5 \times 42.0$	10.2	B32756G2206+000	14.0	3.9	440
		22	$30.0 \times 45.0 \times 42.0$	20.3	B32756G2226+000	16.0	3.6	400
		25	$33.0 \times 48.0 \times 42.0$	20.3	B32756G2256+000	17.0	3.2	180
		30	$33.0 \times 48.0 \times 42.0$	20.3	B32756G2306K000	18.0	3.0	180
275	550	5.0	$18.0 \times 32.5 \times 42.0$	_	B32756C7505+000	7.0	12.2	720
		6.0	$18.0 \times 32.5 \times 42.0$	_	B32756C7605+000	7.0	10.3	720
		7.0	$18.0 \times 32.5 \times 42.0$	_	B32756C7705+000	8.0	9.7	720
		8.0	$20.0 \times 39.5 \times 42.0$	10.2	B32756G7805+000	9.0	7.5	640
		9.0	$20.0 \times 39.5 \times 42.0$	10.2	B32756G7905+000	10.0	6.9	640
		10	$20.0 \times 39.5 \times 42.0$	10.2	B32756G7106+000	11.0	6.6	640
		12	$22.0 \times 45.0 \times 42.0$	10.2	B32756G7126+000	12.0	5.6	560
		15	$28.0 \times 42.5 \times 42.0$	10.2	B32756G7156+000	14.0	4.5	440
		20	$30.0 \times 45.0 \times 42.0$	20.3	B32756G7206K000	17.0	3.8	400
		22	$33.0 \times 48.0 \times 42.0$	20.3	B32756G7226+000	18.0	3.3	180

MOQ = Minimum Order Quantity, consisting of 4 packing units. Further E series and intermediate capacitance values on request.

## Composition of ordering code

+ = Capacitance tolerance code:

 $K = \pm 10\%$ 





## **MKP AC filtering**

## Ordering codes and packing units (lead spacing 37.5 mm)

$V_{RMS}$	$V_R$	$C_R$	Max. dimensions	P <sub>1</sub>	Ordering code	I <sub>RMS</sub>	ESR <sub>typ</sub>	Untaped
			$w \times h \times l$		(composition see	70 °C	10 kHz	
					below)	10 kHz		
V AC	V DC	μF	mm	mm		Α	$m\Omega$	pcs./MOQ
310	580	5.0	$18.0 \times 32.5 \times 42.0$	_	B32756C3505+000	7.0	12.2	720
		6.0	$18.0 \times 32.5 \times 42.0$	_	B32756C3605+000	8.0	10.3	720
		7.0	$20.0 \times 39.5 \times 42.0$	10.2	B32756G3705+000	9.0	8.5	640
		8.0	$20.0 \times 39.5 \times 42.0$	10.2	B32756G3805+000	10.0	7.5	640
		9.0	$20.0 \times 39.5 \times 42.0$	10.2	B32756G3905+000	11.0	6.9	640
		10	$22.0 \times 45.0 \times 42.0$	10.2	B32756G3106+000	12.0	6.1	560
		12	$22.0 \times 45.0 \times 42.0$	10.2	B32756G3126K000	13.0	5.5	560
		14	$28.0 \times 42.5 \times 42.0$	10.2	B32756G3146K000	14.0	4.7	440
		15	$30.0 \times 45.0 \times 42.0$	20.3	B32756G3156+000	16.0	4.2	400
		20	$33.0 \times 48.0 \times 42.0$	20.3	B32756G3206K000	17.0	3.5	180
350	600	5.0	$18.0 \times 32.5 \times 42.0$	_	B32756C8505+000	8.0	6.0	720
		6.0	$18.0 \times 32.5 \times 42.0$	10.2	B32756G8605+000	9.0	5.4	640
		7.0	$20.0 \times 39.5 \times 42.0$	10.2	B32756G8705+000	10.0	4.7	640
		8.0	$22.0 \times 45.0 \times 42.0$	10.2	B32756G8805+000	11.0	4.2	560
		9.0	$22.0 \times 45.0 \times 42.0$	10.2	B32756G8905+000	12.0	3.9	560
		10	$28.0 \times 42.5 \times 42.0$	10.2	B32756G8106+000	13.0	3.4	440
		12	$30.0 \times 45.0 \times 42.0$	20.3	B32756G8126+000	15.0	2.9	400
		15	$33.0 \times 48.0 \times 42.0$	20.3	B32756G8156+000	16.0	2.6	180
400	800	1.0	$12.0 \times 22.0 \times 42.0$	_	B32756C4105K000	4.0	26.3	1620
		2.0	$16.0 \times 28.5 \times 42.0$	_	B32756C4205+000	6.5	13.3	800
		3.0	$18.0 \times 32.5 \times 42.0$	_	B32756C4305K000	7.0	9.4	720
		4.0	$20.0 \times 39.5 \times 42.0$	10.2	B32756G4405+000	8.5	6.5	640
		5.0	$22.0 \times 45.0 \times 42.0$	10.2	B32756G4505+000	9.5	5.3	560
		6.0	$28.0 \times 42.5 \times 42.0$	10.2	B32756G4605+000	11.0	4.4	440
		7.0	$30.0 \times 45.0 \times 42.0$	20.3	B32756G4705+000	13.0	3.9	400
		8.0	$33.0 \times 48.0 \times 42.0$	20.3	B32756G4805+000	14.0	3.4	180
		9.0	$33.0 \times 48.0 \times 42.0$	20.3	B32756G4905K000	15.0	3.3	180

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further E series and intermediate capacitance values on request.

### Composition of ordering code

+ = Capacitance tolerance code:

 $K = \pm 10\%$ 







## Ordering codes and packing units (lead spacing 52.5 mm)

$\overline{V_{RMS}}$	$V_R$	C <sub>R</sub>	Max. dimensions	P <sub>1</sub>	Ordering code	I <sub>RMS</sub>	ESR <sub>typ</sub>	Untaped
			$w \times h \times l$		(composition see	70 °C	10 kHz	
					below)	10 kHz		
V AC	V DC	μF	mm	mm		Α	mΩ	pcs./MOQ
250	500	20	$30.0\times45.0\times57.5$	20.3	B32758G2206+000	13.0	6.3	280
		22	$30.0\times45.0\times57.5$	20.3	B32758G2226+000	13.0	5.8	280
		25	$30.0\times45.0\times57.5$	20.3	B32758G2256+000	14.0	5.6	280
		30	$30.0\times45.0\times57.5$	20.3	B32758G2306+000	16.0	5.4	280
		35	$30.0 \times 45.0 \times 57.5$	20.3	B32758G2356K000	17.0	4.8	280
		40	$35.0\times50.0\times57.5$	20.3	B32758G2406+000	20.0	4.2	108
		45	$35.0\times50.0\times57.5$	20.3	B32758G2456K000	21.0	3.8	108
		50	$38.0\times57.5\times57.5$	20.3	B32758G2506+000	22.0	3.6	96
		55	$38.0\times57.5\times57.5$	20.3	B32758G2556+000	24.0	3.3	96
		60	$38.0\times57.5\times57.5$	20.3	B32758G2606K000	25.0	3.1	96
		65	$45.0 \times 57.0 \times 57.5$	20.3	B32758G2656+000	26.0	2.9	140
		70	$45.0 \times 57.0 \times 57.5$	20.3	B32758G2706K000	27.0	2.7	140
275	550	20	$30.0 \times 45.0 \times 57.5$	20.3	B32758G7206+000	13.0	6.3	280
		22	$30.0 \times 45.0 \times 57.5$	20.3	B32758G7226+000	14.0	5.8	280
		25	$30.0\times45.0\times57.5$	20.3	B32758G7256+000	15.0	5.6	280
		30	$35.0\times50.0\times57.5$	20.3	B32758G7306+000	17.0	4.6	108
		35	$35.0\times50.0\times57.5$	20.3	B32758G7356+000	20.0	4.2	108
		40	$38.0\times57.5\times57.5$	20.3	B32758G7406+000	21.0	3.9	96
		45	$38.0\times57.5\times57.5$	20.3	B32758G7456+000	23.0	3.6	96
		50	$45.0 \times 57.0 \times 57.5$	20.3	B32758G7506+000	24.0	3.2	140
		55	$45.0 \times 57.0 \times 57.5$	20.3	B32758G7556K000	25.0	3.0	140

MOQ = Minimum Order Quantity, consisting of 4 packing units. Further E series and intermediate capacitance values on request.

### Composition of ordering code

+ = Capacitance tolerance code:

 $K = \pm 10\%$ 





## **MKP AC filtering**

## Ordering codes and packing units (lead spacing 52.5 mm)

$V_{RMS}$	$V_R$	$C_R$	Max. dimensions	P <sub>1</sub>	Ordering code	I <sub>RMS</sub>	ESR <sub>typ</sub>	Untaped
			$w \times h \times l$		(composition see	70 °C	10 kHz	
					below)	10 kHz		
V AC	V DC	μF	mm	mm		Α	mΩ	pcs./MOQ
310	580	20	$30.0 \times 45.0 \times 57.5$	20.3	B32758G3206+000	15.0	6.3	280
		22	$30.0\times45.0\times57.5$	20.3	B32758G3226+000	16.0	5.8	280
		25	$35.0\times50.0\times57.5$	20.3	B32758G3256+000	18.0	5.2	108
		30	$35.0\times50.0\times57.5$	20.3	B32758G3306+000	20.0	4.3	108
		35	$38.0\times57.5\times57.5$	20.3	B32758G3356+000	22.0	3.9	96
		40	$38.0\times57.5\times57.5$	20.3	B32758G3406K000	24.0	3.6	96
		45	$45.0\times57.0\times57.5$	20.3	B32758G3456K000	26.0	3.3	140
350	600	15	$30.0\times45.0\times57.5$	20.3	B32758G8156+000	14.0	4.1	280
		20	$35.0\times50.0\times57.5$	20.3	B32758G8206+000	16.0	3.3	108
		22	$35.0\times50.0\times57.5$	20.3	B32758G8226+000	18.0	3.1	108
		25	$35.0\times50.0\times57.5$	20.3	B32758G8256K000	19.0	2.9	108
		30	$38.0\times57.5\times57.5$	20.3	B32758G8306+000	22.0	2.5	96
		33	$38.0\times57.5\times57.5$	20.3	B32758G8336K000	23.0	2.4	96
400	800	9.0	$38.0\times57.5\times57.5$	20.3	B32758G4905+000	13.0	5.2	280
		10	$30.0 \times 45.0 \times 57.5$	20.3	B32758G4106+000	14.0	4.8	280
		12	$35.0 \times 50.0 \times 57.5$	20.3	B32758G4126+000	16.0	4.0	108
		15	$38.0\times57.5\times57.5$	20.3	B32758G4156+000	18.0	3.3	96

MOQ = Minimum Order Quantity, consisting of 4 packing units.

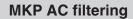
Further E series and intermediate capacitance values on request.

### Composition of ordering code

+ = Capacitance tolerance code:

 $K = \pm 10\%$ 







### **Technical data**

Reference standard: IEC 61071:2007	all data given at $T = 20  ^{\circ}C$	unless otherwise specified.
------------------------------------	---------------------------------------	-----------------------------

,		
Operating temperature range (case)	Max. operating temperature, $T_{op,r}$	<sub>max</sub> +105 °C
	Upper category temperature T <sub>max</sub>	, +85 °C
	Lower category temperature T <sub>min</sub>	–40 °C
	Note:	
	At T > 85 $^{\circ}$ C derating for $V_{RMS}$ (V	AC) should be 1.5%/°C
Dissipation factor tan δ (in 10 <sup>-3</sup> )	1.0, C <sub>R</sub> ≤ 55 μF	
at 20 °C and 1kHz (upper limit values)	1.2, C <sub>R</sub> > 55 μF	
Insulation resistance R <sub>ins</sub> after 1min,	10 000 s	
given as time constant		
$\tau = C_R \cdot R_{ins}$ , rel. humidity $\leq 65\%$		
(minimum as-delivered values)		
Measuring voltage: 100 V DC		
DC test voltage between terminals	1.5 · V <sub>R</sub> for 10 s	
	1.6 · V <sub>R</sub> for 2 s	
DC test voltage terminal to case	2000 V AC at 50 Hz, 60 s	
Maximum peak current (A)	$I_{P,max} = C_R \cdot \frac{dV}{dt}$	
THB to high robustness under high	Temperature T:	60 °C ±2ºC
humidity, refer to	Relative humidity:	95% ±2%
IEC 60384-14:2013/AMD1:2016	Applied voltage:	V <sub>RMS</sub> (50/60Hz)
Grade III Test A	Test duration:	1344 h
Criteria for passing THB test	Capacitance change	$ \Delta C/C_0  \le 10\%$
	Dissipation factor change	$\Delta tan\delta \le 0.005$
	Insulation resistance R <sub>ins</sub>	≥ 50% specified limit
Change of temperature	In accordance with IEC 60068-2-	-14:2009 (Test Nb)
Reliability:		
Failure rate $\lambda$	10 fit (≤10 × 10 <sup>-9</sup> /h)	
Service life t <sub>SL</sub>	> 60 000 h at 0.9 V <sub>B</sub> , 70 °C	
0_	For conversion to other operating	g conditions and
	temperatures, refer to chapter "C	Quality, 2 Reliability".
Failure criteria:		
Total failure	Short/open circuit	
Failure due to variation of	Capacitance change $ \Delta C/C_0 $	≥ 10%
parameters	Dissipation factor change $\Delta$ tan $\delta$	
•	Insulation resistance R <sub>ins</sub>	- F F
	or time constant $\tau = C_R \cdot R_{ins}$	< 500 s
	11 1115	





#### **MKP AC filtering**

### Pulse handling capability

"dV/dt" represents the maximum permissible voltage change per unit of time for non-sinusoidal voltages, expressed in  $V/\mu s$ .

"k0" represents the maximum permissible pulse characteristic of the waveform applied to the capacitor, expressed in  $V^2/\mu s$ .

#### Note:

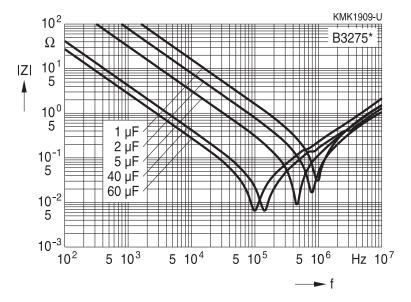
The values of dV/dt and k0 provided below must not be exceeded in order to avoid damaging the capacitor. These parameters are given for isolated pulses in such a way that the heat generated by one pulse will be completely dissipated before applying the next pulse. For a train of pulses, please refer to the curves of permissible AC voltage-current versus frequency

Lead spacing		2	27.5 mm	1			(	37.5 mm	1	
Туре			B32754					B32756		_
V <sub>R</sub> (V DC)	500	550	580	600	800	500	550	580	600	800
V <sub>RMS</sub> (V AC)	250	275	310	350	400	250	275	310	350	400
	dV/dt			dV/dt i	n V/µs					
	50	55	68	80	100	25	30	35	50	60

Lead spacing	52.5 mm				
Туре	B32758				
V <sub>R</sub> (V DC)	500	550	580	600	800
V <sub>RMS</sub> (V AC)	250	275	310	350	400
		dV	/dt in V	/μs	
	13	15	17	25	30

#### Impedance Z versus frequency f

(typical values)







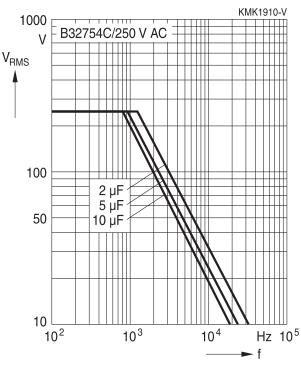


## Permissible AC voltage V<sub>RMS</sub> versus frequency f (for sinusoidal waveforms, T<sub>op</sub> ≤85 °C)

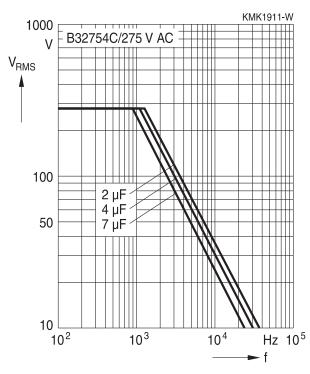
For  $T_{op}$  >85 °C, please refer to derating curve. The maximum component surface temperature must be lower than 105 °C and maximum temperature rise between case and free ambient shall be lower than 15 °C.

#### Lead spacing 27.5 mm

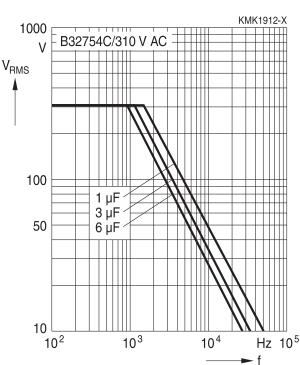
500 V DC/250 V AC



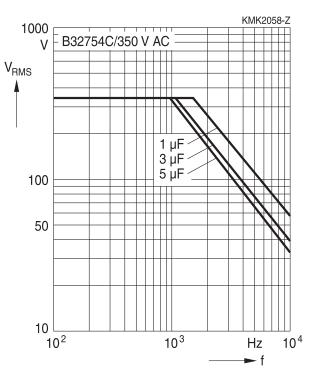
#### 550 V DC/275 V AC



580 V DC/310 V AC



600 V DC/350 V AC





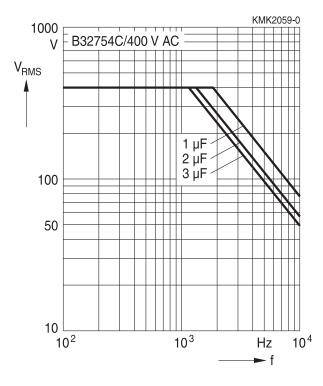


## Permissible AC voltage $V_{RMS}$ versus frequency f (for sinusoidal waveforms, $T_{op} \le 85$ °C)

For  $T_{op}$  >85 °C, please refer to derating curve. The maximum component surface temperature must be lower than 105 °C and maximum temperature rise between case and free ambient shall be lower than 15 °C.

### Lead spacing 27.5 mm

800 V DC/400 V AC







#### **MKP AC filtering**

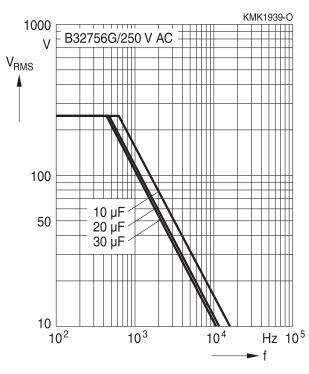


## Permissible AC voltage V<sub>RMS</sub> versus frequency f (for sinusoidal waveforms, T<sub>op</sub> ≤85 °C)

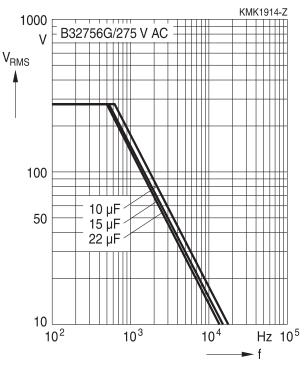
For  $T_{op}$  >85 °C, please refer to derating curve. The maximum component surface temperature must be lower than 105 °C and maximum temperature rise between case and free ambient shall be lower than 15 °C.

### Lead spacing 37.5 mm (2 pins, 4 pins)

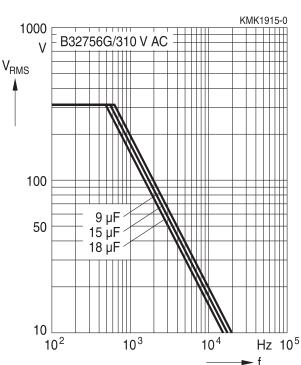
500 V DC/250 V AC



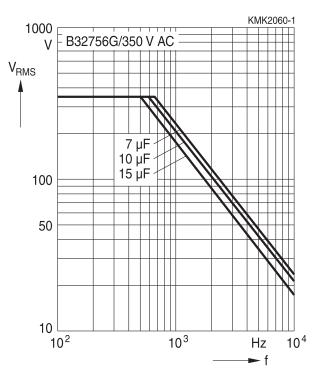
#### 550 V DC/275 V AC



580 V DC/310 V AC



600 V DC/350 V AC







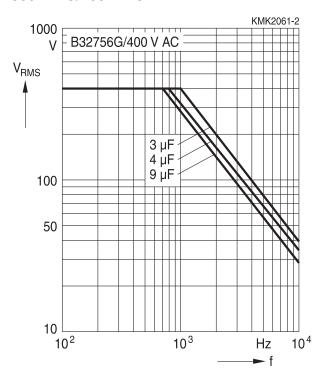
## **MKP AC filtering**

## Permissible AC voltage $V_{RMS}$ versus frequency f (for sinusoidal waveforms, $T_{op} \le 85$ °C)

For  $T_{op}$  >85 °C, please refer to derating curve. The maximum component surface temperature must be lower than 105 °C and maximum temperature rise between case and free ambient shall be lower than 15 °C.

### Lead spacing 37.5 mm (2 pins, 4 pins)

800 V DC/400 V AC







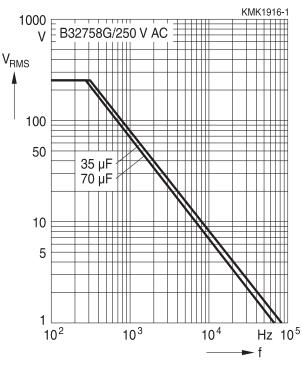


## Permissible AC voltage V<sub>RMS</sub> versus frequency f (for sinusoidal waveforms, T<sub>op</sub> ≤85 °C)

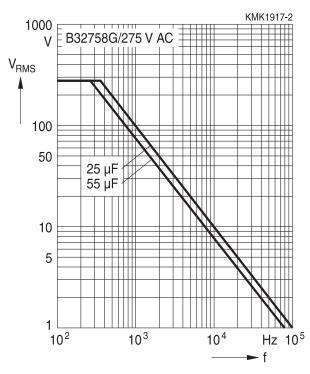
For  $T_{op}$  >85 °C, please refer to derating curve. The maximum component surface temperature must be lower than 105 °C and maximum temperature rise between case and free ambient shall be lower than 15 °C.

#### Lead spacing 52.5 mm

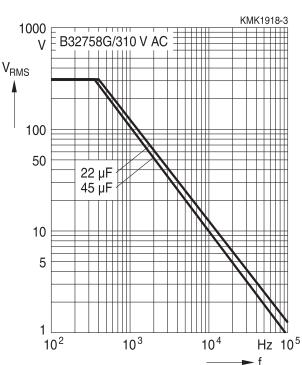
500 V DC/250 V AC



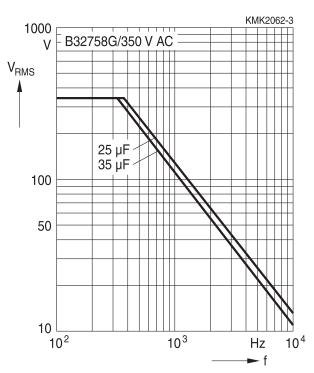
#### 550 V DC/275 V AC



580 V DC/310 V AC



600 V DC/350 V AC







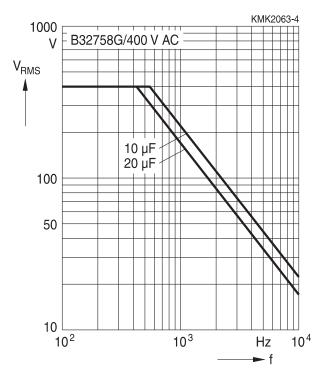
## **MKP AC filtering**

## Permissible AC voltage $V_{RMS}$ versus frequency f (for sinusoidal waveforms, $T_{op} \le 85$ °C)

For  $T_{op}$  >85 °C, please refer to derating curve. The maximum component surface temperature must be lower than 105 °C and maximum temperature rise between case and free ambient shall be lower than 15 °C.

### Lead spacing 52.5 mm

800 V DC/400 V AC







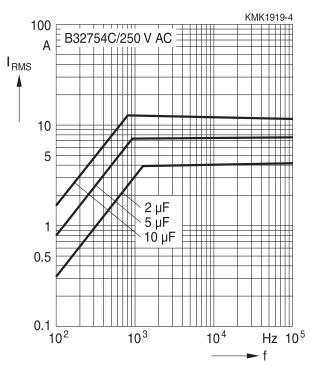


## Permissible current I<sub>RMS</sub> versus frequency f (for sinusoidal waveforms T<sub>op</sub> ≤85 °C)

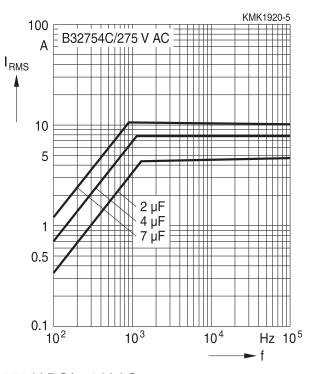
For  $T_{op}$  >85 °C, please use the derating curve. The maximum component surface temperature must be lower than 105 °C and maximum temperature rise between case and free ambient shall be lower than 15 °C.

#### Lead spacing 27.5 mm

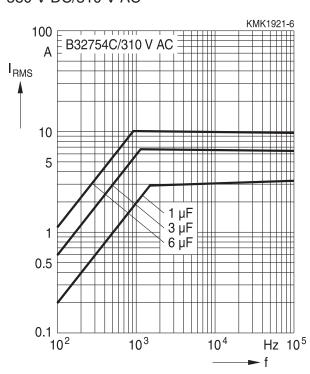
500 V DC/250 V AC



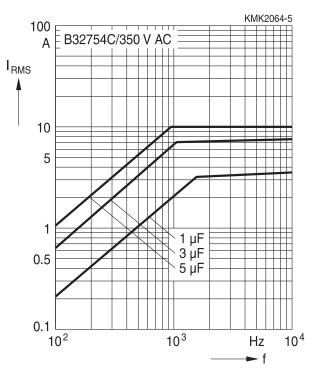
550 V DC/275 V AC



580 V DC/310 V AC



600 V DC/350 V AC





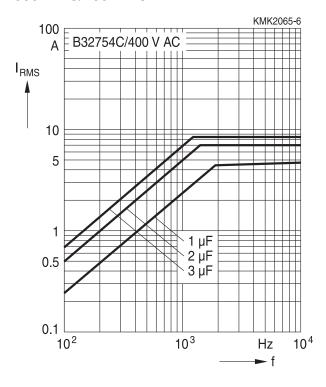


## Permissible current $I_{RMS}$ versus frequency f (for sinusoidal waveforms $T_{op} \le 85$ °C)

For  $T_{op}$  >85 °C, please use the derating curve. The maximum component surface temperature must be lower than 105 °C and maximum temperature rise between case and free ambient shall be lower than 15 °C.

## Lead spacing 27.5 mm

800 V DC/400 V AC







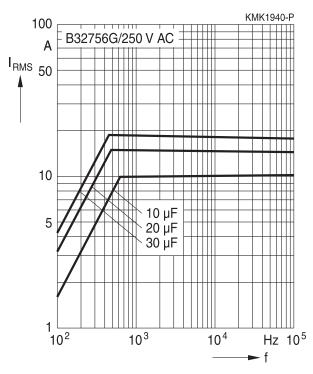


## Permissible current I<sub>RMS</sub> versus frequency f (for sinusoidal waveforms T<sub>op</sub> ≤85 °C)

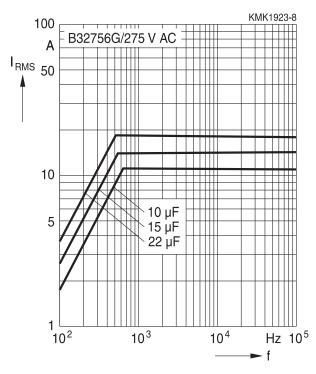
For  $T_{op}$  >85 °C, please use the derating curve. The maximum component surface temperature must be lower than 105 °C and maximum temperature rise between case and free ambient shall be lower than 15 °C.

### Lead spacing 37.5 mm (2 pins, 4 pins)

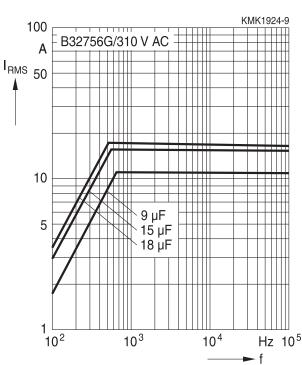
500 V DC/250 V AC



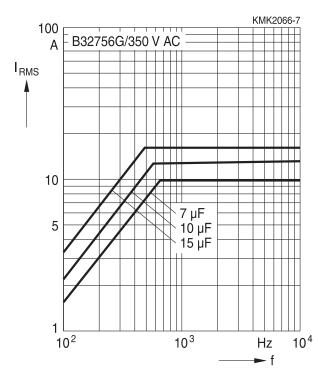
#### 550 V DC/275 V AC



580 V DC/310 V AC



600 V DC/350 V AC

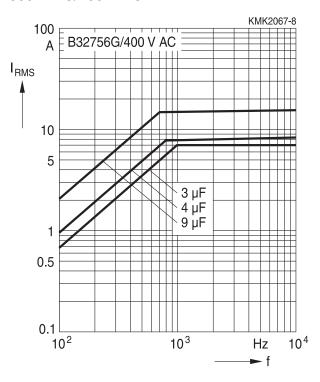






## **MKP AC filtering**

## 800 V DC/400 V AC







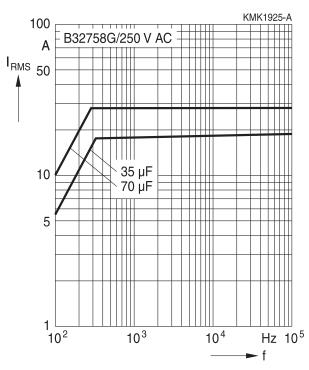


## Permissible current I<sub>RMS</sub> versus frequency f (for sinusoidal waveforms T<sub>op</sub> ≤85 °C)

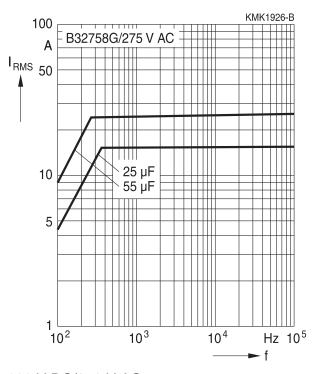
For  $T_{op}$  >85 °C, please use the derating curve. The maximum component surface temperature must be lower than 105 °C and maximum temperature rise between case and free ambient shall be lower than 15 °C.

#### Lead spacing 52.5 mm

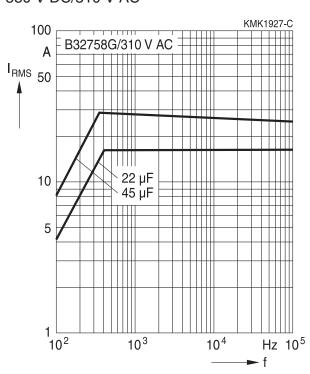
500 V DC/250 V AC



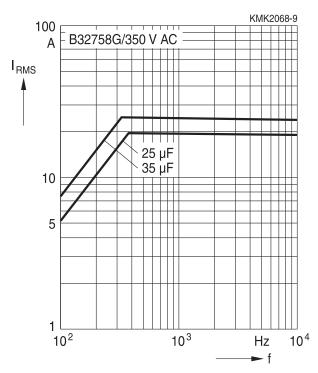
550 V DC/275 V AC



580 V DC/310 V AC



600 V DC/350 V AC







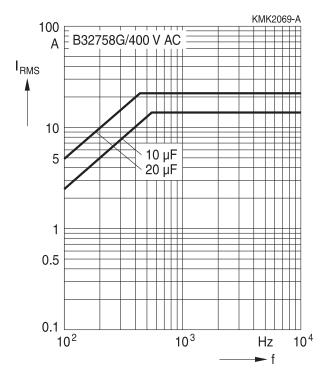
## **MKP AC filtering**

## Permissible current $I_{RMS}$ versus frequency f (for sinusoidal waveforms $T_{op} \le 85$ °C)

For  $T_{op}$  >85 °C, please use the derating curve. The maximum component surface temperature must be lower than 105 °C and maximum temperature rise between case and free ambient shall be lower than 15 °C.

## Lead spacing 52.5 mm

800 V DC/400 V AC

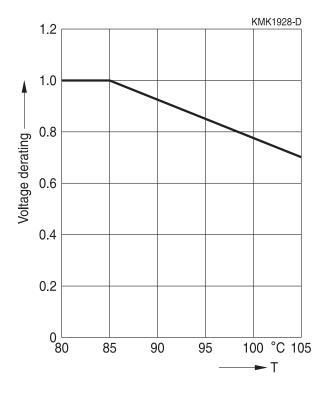








## Maximum permissible continuous DC voltage versus temperature T







#### **MKP AC filtering**

## Maximum AC voltage (V<sub>RMS</sub>) versus temperature T<sub>op</sub> ≤85 °C

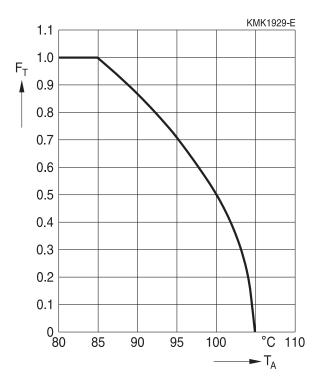
The graphs described in the previous section for the maximum AC voltage versus frequency are valid for moderate temperature:  $T_{op} \le 85$  °C in MKP. For temperatures higher than these limits, we have to consider additional effects depending on the frequency and dielectric:

Low frequency (f <f1)

For frequency below f1 (the frequency is the  $V_{\text{RMS}}$  begin to derating versus frequency), a derating of the  $V_{\text{RMS}}$  versus the working temperature has to be applied, following the rules defined above.

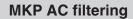
High frequencies (f1 ≤f)

For frequency below f1 (The frequency is the  $V_{\text{RMS}}$  begin to derating versus frequency), a derating of the  $V_{\text{RMS}}$  versus the working temperature has to be applied, following the rules defined as below:



Derating factor  $F_T$  for  $V_{\text{RMS}}$  versus  $T_A$ 







## **Testing and Standards**

Test	Reference	Conditions of tes	t		Performance requirements
Electrical parameters	IEC 61071:2007	Voltage between terminals: 1.5 V <sub>R</sub> , 60 s		Within specified limits No visible damage	
		Terminals and end	losure: 20	000 V AC	No flashover
		Insulation resistant Capacitance C <sub>R</sub> Dissipation factor t			
Robustness	IEC	Tensile strength (to	est U <sub>a</sub> 1)		Within specified
of termina- tions	60068-2-21:2006	Wire diameter	Section	Tensile force	specification
		$0.5 < d_1 \le 0.8 \text{ mm}$ $0.8 < d_1 \le 1.25 \text{ mm}$	≤0.5m <sup>2</sup> ≤1.2m <sup>2</sup>	10 N 20 N	
		Duration: $10 s +/-$	1	ı	
		Bending U <sub>b</sub> metho	d 1		-
		Wire diameter	Section	Tensile force	
		$0.5 < d_1 \le 0.8 \text{ mm}$ $0.8 < d_1 \le 1.25 \text{ mm}$	≤0.5m <sup>2</sup> ≤1.2m <sup>2</sup>	10 N 20 N	
		4 × 90 °C Duration: 2 s to 3 s	s / bend	1	
Resistance	IEC	Solder bath temperature at 260 ±5 °C,			ΔC/C <sub>0</sub> ≤0.5%
to solder-	_	immersion for 10 s		•	Increase of
ing heat					tan δ ≤0.005
Vibration	IEC	10 Hz to 55 Hz:			No visible damage
	60068-2-6:2007	Amplitude ±0.35 m acceleration 98 m/			
		Test duration: 10 f	requency	cycles,	
		3 axes offset from	each othe	er by 90°,	
		1 octave/min,			
		Visual examination			
Bump	IEC	Pulse shape: half s			No visible damage
	60068-2-6:2007	Acceleration: 490			$ \Delta C/C_0  \le 0.5\%$ Increase of
		Duration of pulse: Visual examination			tan δ ≤0.005 compared
		Visual examination			to initial value
Damp heat test		60 °C / 95% RH / V <sub>R, AC</sub> / 1000 h			$\begin{split}  \Delta C/C_0  &\leq 10\% \\  \Delta \ tan \ \delta  &\leq 500\% \ (10 \ kHz) \\ R_{ins} &\geq 50\% \ of \ minimum \ as \\ delivered \ value \end{split}$

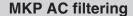




## **MKP AC filtering**

Test	Reference	Conditions of test	Performance requirements
Surge test	IEC 61071:2007	$1.1 \cdot V_R$ or $I_{test} = 1.1 I_{max}$ . Number of discharges: 5 Time lapse: every 2 min (10 min total) within 5 min after the surge discharge test Duration: 10 s; $1.5 \cdot V_R$ at $T_A$	No visible damage $ \Delta C/C_0  \le 1\%$ tan $\delta$ (10 kHz) $\le 1.2$ initial tan $\delta$ +0.0001
Self-healing	IEC 61071:2007	1.5 · V <sub>R</sub> ; duration 10 s  Number of clearings: ≤5  Clearing = voltage drop of 5%  Increase the voltage at 100 V/s till  5 clearings occur with a maximum of  2.5 · V <sub>R</sub> for a duration of 10 s	$ \Delta C/C_0  \le 0.5\%$ tan $\delta$ (10 kHz) $\le 1.12$ initial tan $\delta$ +0.0001
Environ- mental	IEC 61071:2007	<ol> <li>Change of temperature acc. to IEC 60068-2-14, test N<sub>b</sub>         T<sub>max.</sub> = 85 °C, T<sub>min.</sub> = -40 °C,         Transition time:         1 h, equiv. to 1 °C/min, 5 cycles         2. Damp heat steady state acc. to IEC 60068-2-78, test C<sub>a</sub>         T = 40 °C ±2 °C, RH = 93% ±3 %,         Duration: 56 days         3. DC voltage between terminal,         1.5 · V<sub>R</sub> at ambient temperature         Duration: 10 s</li> </ol>	No puncturing or flashover Self-healing punctures permitted $ \Delta C/C_0  \leq \!\! 2\%$ Increase of tan $\delta$ (10 kHz) $\leq \!\! 0.015$
Thermal stability test under overload conditions	IEC 61071:2007	Natural cooling $T_A \pm 5$ °C 1.21 · $P_{max.} = (V_2/2) \cdot W_2 \cdot C \cdot \tan \delta =$ 1.21 · $(I_{max.}^2/W_2 \cdot C) \cdot \tan \delta_2$ with $W_2 = 2 \cdot \pi \cdot f_2$ for $I_{max.}$ (see specific reference data) $f_2 = 10$ kHz, duration 48 h Measure the temperature every 1.5 h during the last 6 h	Temperature rise <1 °C $ \Delta C/C_0  \leq 2\%$ Increase of tan $\delta$ (10 kHz) $\leq$ 1.2 initial tan $\delta$ +0.015
Endurance test between terminal	IEC 61071:2007	Sequence: $1.25 \cdot V_R \text{ at } T_{max.} = 85  ^{\circ}\text{C}$ $1.0 \cdot V_R \text{ at } T_{max.} = 105  ^{\circ}\text{C}$ $Duration: 500  h$ $1000 \times \text{discharge at } 1.4 \cdot \text{I}$ $(max.\text{repetitive peak current in continuous operation})$ $1.25 \cdot V_R \text{ at } T_{max.} = 85  ^{\circ}\text{C}$ $1.0 \cdot V_R \text{ at } T_{max.} = 105  ^{\circ}\text{C}$ $Duration: 500  h$	$ \Delta C/C_0  \le 3\%$ Increase of tan $\delta \le 0.015$ compared to initial value







### **Mounting guidelines**

## 1 Soldering

### 1.1 Solderability of leads

The solderability of terminal leads is tested to IEC 60068-2-20:2008, test Ta, method 1.

Before a solderability test is carried out, terminals are subjected to accelerated ageing (to IEC 60068-2-2:2007, test Ba: 4 h exposure to dry heat at 155 °C). Since the ageing temperature is far higher than the upper category temperature of the capacitors, the terminal wires should be cut off from the capacitor before the ageing procedure to prevent the solderability being impaired by the products of any capacitor decomposition that might occur.

Solder bath temperature	235 ±5 °C
Soldering time	2.0 ±0.5 s
Immersion depth	2.0 + 0/-0.5 mm from capacitor body or seating plane
Evaluation criteria:	
Visual inspection	Wetting of wire surface by new solder ≥90%, free-flowing solder

### 1.2 Resistance to soldering heat

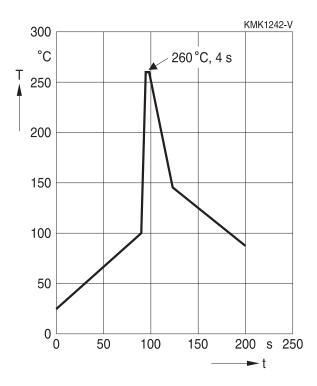
Resistance to soldering heat is tested to IEC 60068-2-20:2008, test Tb, method 1. Conditions:

Serie	S	Solder bath temperature	Soldering time
MKT	boxed (except $2.5 \times 6.5 \times 7.2$ mm) coated uncoated (lead spacing >10 mm)	260 ±5 °C	10 ±1 s
MFP MKP	(lead spacing >7.5 mm)		
MKT	boxed (case $2.5 \times 6.5 \times 7.2$ mm)		5 ±1 s
MKP MKT	(lead spacing ≤7.5 mm) uncoated (lead spacing ≤10 mm) insulated (B32559)		<4 s recommended soldering profile for MKT uncoated (lead spacing ≤ 10 mm) and insulated (B32559)





#### **MKP AC filtering**



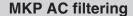
Immersion depth	2.0 +0/-0.5 mm from capacitor body or seating plane
Shield	Heat-absorbing board, (1.5 ±0.5) mm thick, between
	capacitor body and liquid solder
Evaluation criteria:	
Visual inspection	No visible damage
$\Delta C/C_0$	2% for MKT/MKP/MFP
∆O/O <sub>0</sub>	5% for EMI suppression capacitors
$tan \delta$	As specified in sectional specification

### 1.3 General notes on soldering

Permissible heat exposure loads on film capacitors are primarily characterized by the upper category temperature  $T_{\text{max}}$ . Long exposure to temperatures above this type-related temperature limit can lead to changes in the plastic dielectric and thus change irreversibly a capacitor's electrical characteristics. For short exposures (as in practical soldering processes) the heat load (and thus the possible effects on a capacitor) will also depend on other factors like:

- Pre-heating temperature and time
- Forced cooling immediately after soldering
- Terminal characteristics: diameter, length, thermal resistance, special configurations (e.g. crimping)
- Height of capacitor above solder bath
- Shadowing by neighboring components
- Additional heating due to heat dissipation by neighboring components
- Use of solder-resist coatings



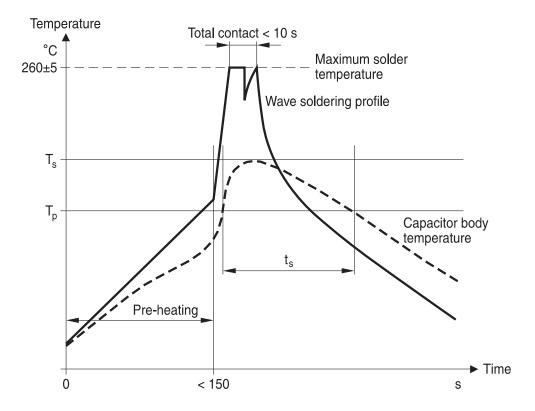




The overheating associated with some of these factors can usually be reduced by suitable countermeasures. For example, if a pre-heating step cannot be avoided, an additional or reinforced cooling process may possibly have to be included.

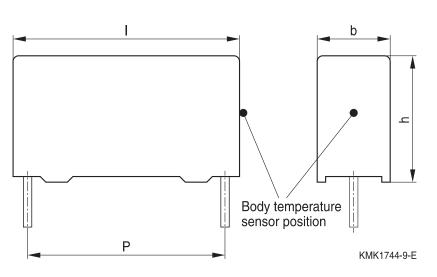
#### Recommendations

As a reference, the recommended wave soldering profile for our film capacitors is as follows:



T<sub>s</sub>: Capacitor body maximum temperature at wave soldering

 $T_{\rm p}$ : Capacitor body maximum temperature at pre-heating KMK1745-A-E







#### MKP AC filtering

Body temperature should follow the description below:

MKP capacitor

During pre-heating:  $T_p \le 110 \, ^{\circ}\text{C}$ During soldering:  $T_s \le 120 \, ^{\circ}\text{C}$ ,  $t_s \le 45 \, \text{s}$ 

MKT capacitor

During pre-heating: T<sub>p</sub> ≤125 °C

During soldering:  $T_s \le 160$  °C,  $t_s \le 45$  s

When SMD components are used together with leaded ones, the film capacitors should not pass into the SMD adhesive curing oven. The leaded components should be assembled after the SMD curing step.

Leaded film capacitors are not suitable for reflow soldering.

In order to ensure proper conditions for manual or selective soldering, the body temperature of the capacitor ( $T_s$ ) must be  $\leq 120$  °C.

One recommended condition for manual soldering is that the tip of the soldering iron should be <360 °C and the soldering contact time should be no longer than 3 seconds.

For uncoated MKT capacitors with lead spacings ≤10 mm (B32560/B32561) the following measures are recommended:

- pre-heating to not more than 110 °C in the preheater phase
- rapid cooling after soldering

Please refer to our Film Capacitors Data Book in case more details are needed.







#### **Cautions and warnings**

- Do not exceed the upper category temperature (UCT).
- Do not apply any mechanical stress to the capacitor terminals.
- Avoid any compressive, tensile or flexural stress.
- Do not move the capacitor after it has been soldered to the PC board.
- Do not pick up the PC board by the soldered capacitor.
- Do not place the capacitor on a PC board whose PTH hole spacing differs from the specified lead spacing.
- Do not exceed the specified time or temperature limits during soldering.
- Avoid external energy inputs, such as fire or electricity.
- Avoid overload of the capacitors.
- Consult us if application is with severe temperature and humidity condition.
- There are no serviceable or repairable parts inside the capacitor. Opening the capacitor or any attempts to open or repair the capacitor will void the warranty and liability of TDK Electronics.
- Please note that the standards referred to in this publication may have been revised in the meantime.

The table below summarizes the safety instructions that must always be observed. A detailed description can be found in the relevant sections of the chapters "General technical information" and "Mounting guidelines".

Topic	Safety information	Reference chapter "General technical information"
Storage conditions	Make sure that capacitors are stored within the specified range of time, temperature and humidity	4.5 "Storage conditions"
	conditions.	Storage containents
Flammability	Avoid external energy, such as fire or electricity (passive flammability), avoid overload of the capacitors (active flammability) and consider the flammability of materials.	5.3 "Flammability"
Resistance to vibration	Do not exceed the tested ability to withstand vibration. The capacitors are tested to IEC 60068-2-6:2007. TDK Electronics offers film capacitors specially designed for operation under more severe vibration regimes such as those found in automotive applications. Consult our catalog "Film Capacitors for Automotive Electronics".	5.2 "Resistance to vibration"





### **MKP AC filtering**

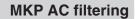
Topic	Safety information	Reference chapter "Mounting guidelines"
Soldering	Do not exceed the specified time or temperature limits during soldering.	1 "Soldering"
Cleaning	Use only suitable solvents for cleaning capacitors.	2 "Cleaning"
Embedding of capacitors in finished assemblies	When embedding finished circuit assemblies in plastic resins, chemical and thermal influences must be taken into account.  Caution: Consult us first, if you also wish to embed other uncoated component types!	3 "Embedding of capacitors in finished assemblies"

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Detailed information can be found on the Internet under www.tdk-electronics.tdk.com/orderingcodes.







## Symbols and terms

Symbol	English	German
α	Heat transfer coefficient	Wärmeübergangszahl
$\alpha_{\text{C}}$	Temperature coefficient of capacitance	Temperaturkoeffizient der Kapazität
Α	Capacitor surface area	Kondensatoroberfläche
$\beta_{C}$	Humidity coefficient of capacitance	Feuchtekoeffizient der Kapazität
С	Capacitance	Kapazität
$C_R$	Rated capacitance	Nennkapazität
$\Delta C$	Absolute capacitance change	Absolute Kapazitätsänderung
ΔC/C	Relative capacitance change (relative deviation of actual value)	Relative Kapazitätsänderung (relative Abweichung vom Ist-Wert)
$\Delta C/C_R$	Capacitance tolerance (relative deviation from rated capacitance)	Kapazitätstoleranz (relative Abweichung vom Nennwert)
dt	Time differential	Differentielle Zeit
$\Delta t$	Time interval	Zeitintervall
ΔΤ	Absolute temperature change (self-heating)	Absolute Temperaturänderung (Selbsterwärmung)
$\Delta tan \delta$	Absolute change of dissipation factor	Absolute Änderung des Verlustfaktors
$\Delta V$	Absolute voltage change	Absolute Spannungsänderung
dV/dt	Time differential of voltage function (rate of voltage rise)	Differentielle Spannungsänderung (Spannungsflankensteilheit)
$\Delta V/\Delta t$	Voltage change per time interval	Spannungsänderung pro Zeitintervall
E	Activation energy for diffusion	Aktivierungsenergie zur Diffusion
ESL	Self-inductance	Eigeninduktivität
ESR	Equivalent series resistance	Ersatz-Serienwiderstand
f	Frequency	Frequenz
f <sub>1</sub>	Frequency limit for reducing permissible AC voltage due to thermal limits	Grenzfrequenz für thermisch bedingte Reduzierung der zulässigen Wechselspannung
$f_2$	Frequency limit for reducing permissible AC voltage due to current limit	Grenzfrequenz für strombedingte Reduzierung der zulässigen Wechselspannung
$f_r$	Resonant frequency	Resonanzfrequenz
$F_D$	Thermal acceleration factor for diffusion	Therm. Beschleunigungsfaktor zur Diffusion
$F_T$	Derating factor	Deratingfaktor
i	Current (peak)	Stromspitze
Ic	Category current (max. continuous current)	Kategoriestrom (max. Dauerstrom)

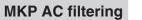




## **MKP AC filtering**

Symbol	English	German
I <sub>RMS</sub>	(Sinusoidal) alternating current,	(Sinusförmiger) Wechselstrom
	root-mean-square value	
i <sub>z</sub>	Capacitance drift	Inkonstanz der Kapazität
$k_0$	Pulse characteristic	Impulskennwert
Ls	Series inductance	Serieninduktivität
λ	Failure rate	Ausfallrate
$\lambda_{0}$	Constant failure rate during useful	Konstante Ausfallrate in der
	service life	Nutzungsphase
$\lambda_{test}$	Failure rate, determined by tests	Experimentell ermittelte Ausfallrate
$P_{diss}$	Dissipated power	Abgegebene Verlustleistung
$P_{gen}$	Generated power	Erzeugte Verlustleistung
Q	Heat energy	Wärmeenergie
ρ	Density of water vapor in air	Dichte von Wasserdampf in Luft
R	Universal molar constant for gases	Allg. Molarkonstante für Gas
R	Ohmic resistance of discharge circuit	Ohmscher Widerstand des
		Entladekreises
$R_i$	Internal resistance	Innenwiderstand
R <sub>ins</sub>	Insulation resistance	Isolationswiderstand
$R_P$	Parallel resistance	Parallelwiderstand
$R_s$	Series resistance	Serienwiderstand
S	severity (humidity test)	Schärfegrad (Feuchtetest)
t	Time	Zeit
Т	Temperature	Temperatur
τ	Time constant	Zeitkonstante
tan $\delta$	Dissipation factor	Verlustfaktor
tan $\delta_{\scriptscriptstyle D}$	Dielectric component of dissipation factor	Dielektrischer Anteil des Verlustfaktors
tan δ <sub>P</sub>	Parallel component of dissipation factor	Parallelanteil des Verlfustfaktors
tan $\delta_{ extsf{S}}$	Series component of dissipation factor	Serienanteil des Verlustfaktors
$T_A$	Temperature of the air surrounding the component	Temperatur der Luft, die das Bauteil umgibt
$T_{max}$	Upper category temperature	Obere Kategorietemperatur
T <sub>min</sub>	Lower category temperature	Untere Kategorietemperatur
t <sub>OL</sub>	Operating life at operating temperature	Betriebszeit bei Betriebstemperatur und
	and voltage	-spannung
T <sub>op</sub>	Operating temperature, $T_A + \Delta T$	Beriebstemperatur, $T_A + \Delta T$
T <sub>R</sub>	Rated temperature	Nenntemperatur
T <sub>ref</sub>	Reference temperature	Referenztemperatur
t <sub>SL</sub>	Reference service life	Referenz-Lebensdauer







Symbol	English	German
$V_{AC}$	AC voltage	Wechselspannung
$V_{C}$	Category voltage	Kategoriespannung
$V_{C,RMS}$	Category AC voltage	(Sinusförmige)
		Kategorie-Wechselspannung
$V_{CD}$	Corona-discharge onset voltage	Teilentlade-Einsatzspannung
$V_{ch}$	Charging voltage	Ladespannung
$V_{DC}$	DC voltage	Gleichspannung
$V_{FB}$	Fly-back capacitor voltage	Spannung (Flyback)
$V_{i}$	Input voltage	Eingangsspannung
$V_{o}$	Output voltage	Ausgangssspannung
$V_{op}$	Operating voltage	Betriebsspannung
$V_p$	Peak pulse voltage	Impuls-Spitzenspannung
$V_{pp}$	Peak-to-peak voltage Impedance	Spannungshub
$V_R$	Rated voltage	Nennspannung
Ŷ <sub>R</sub>	Amplitude of rated AC voltage	Amplitude der Nenn-Wechselspannung
$V_{RMS}$	(Sinusoidal) alternating voltage,	(Sinusförmige) Wechselspannung
	root-mean-square value	
$V_{SC}$	S-correction voltage	Spannung bei Anwendung "S-correction"
$V_{sn}$	Snubber capacitor voltage	Spannung bei Anwendung
		"Beschaltung"
Z	Impedance	Scheinwiderstand
е	Lead spacing	Rastermaß



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The following applies to all products named in this publication:

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#### Important notes

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